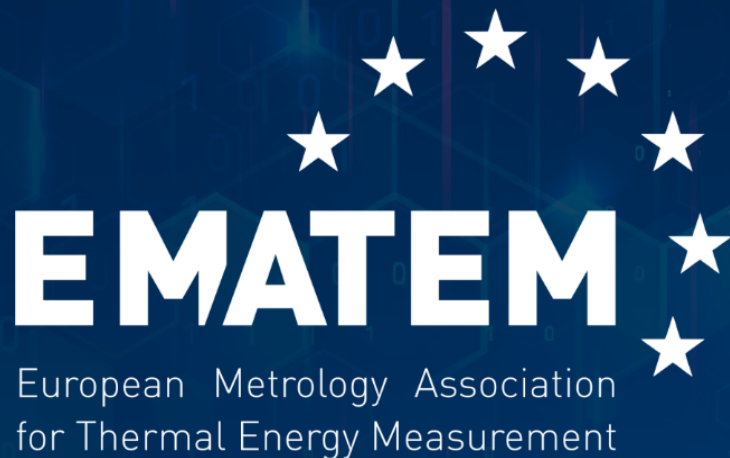


Model for the aging of temperature sensors under cyclic temperature loads for statements on durability above 10 years

20. September 2023 | Seon



Dr. Ivan Jursic

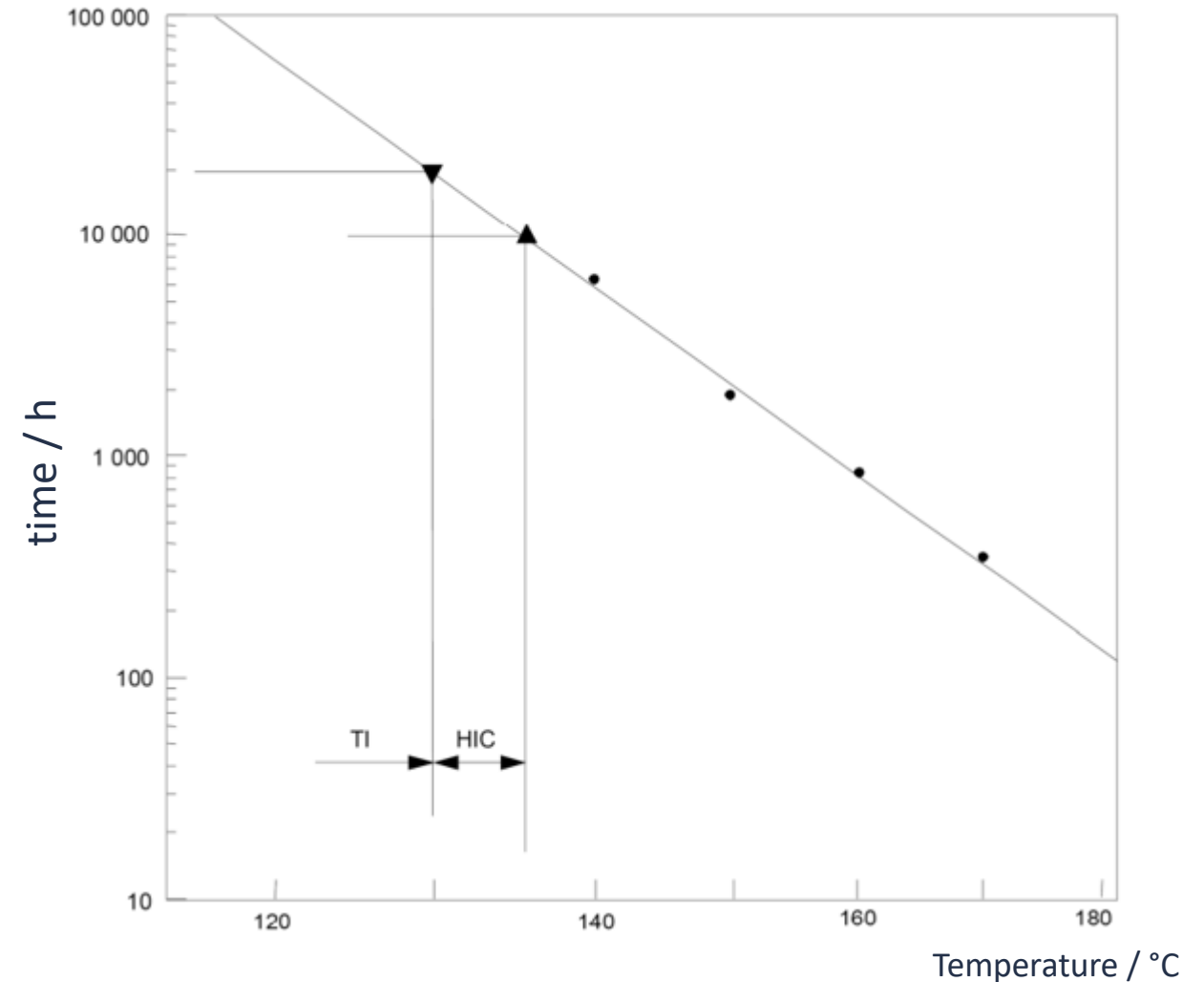
Global Development - Research & Test
Measures and Measuring Methods

- Determine factors affecting durability of temperature probes
- Build a model to calculate expected lifetime
- Develop accelerated test



What is already known in the literature

- Standards from other fields
- Several approaches to accelerated testing
- DIN EN 60216 “Electrical insulating materials – Thermal endurance properties”



- DIN EN 61709, IEC 61709:2011
- Tools for lifetime analysis of a device by lifetime analysis of components
- Definition of failure:

The end of the capability to fulfil its required function.

- One possible interpretation for heat metering of required function:

Thermometer pair is within 1 MPE

- Lifetime for whole device can be calculated from the individual components

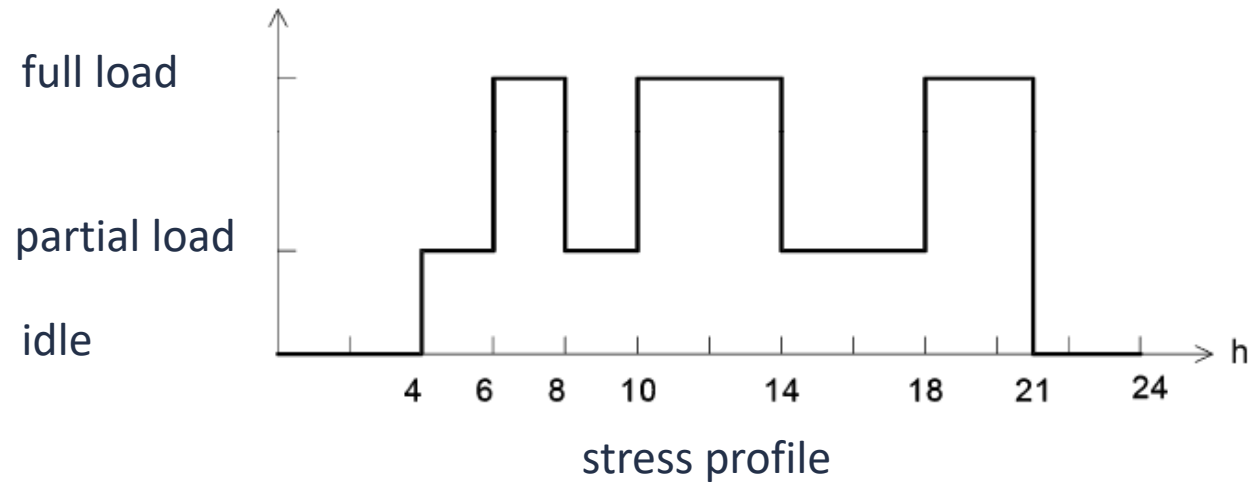
$$\lambda_{component} = \sum_{i=1}^n (\lambda_{mode})_i$$

- General models are not available. Fit to actual failure rates with known stressors:

$$\lambda = \lambda_{ref} \cdot \pi_U \cdot \pi_I \cdot \pi_T \cdot \pi_E \cdot \pi_S \cdot \pi_{ES}$$

- Failure mechanisms are modelled, e.g.:
Voltage, current, temperature, environment, duty cycle, electrical stress

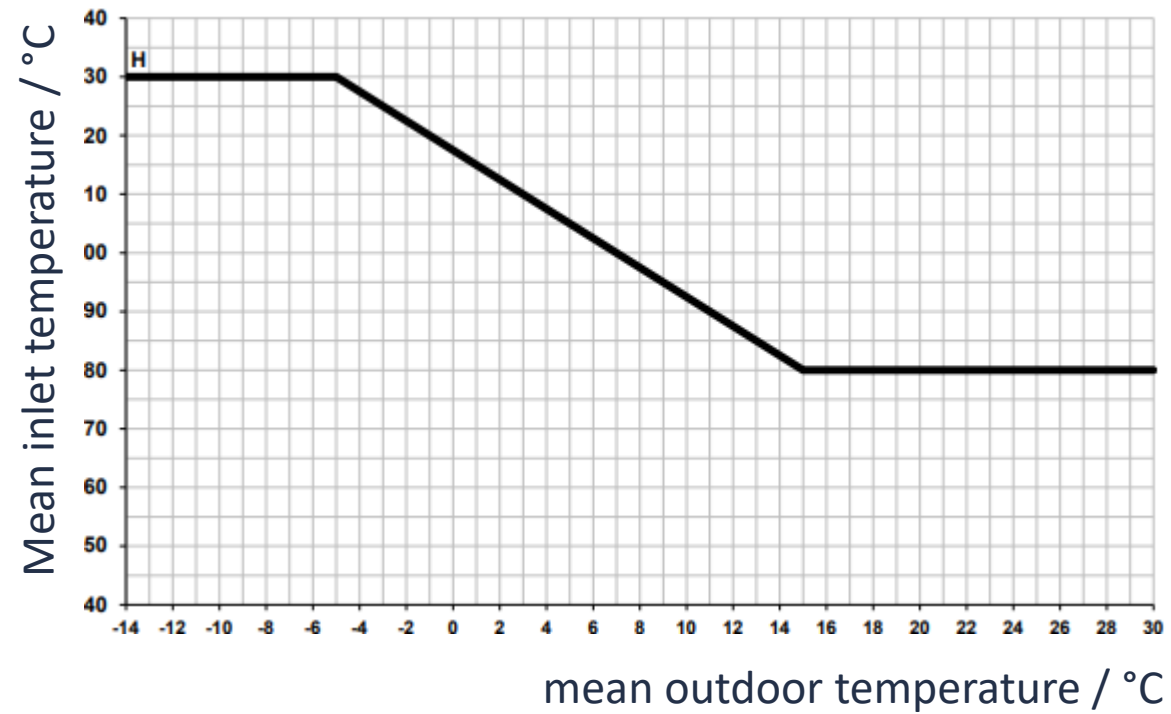
- Real life applications are not binary in stress
- Example from standard:



$$\lambda_{as} = \frac{1}{t_f + t_p + t_i} (t_f \lambda_f + t_p \lambda_p + t_i \lambda_i)$$

Stress profile for heat meters?

- We have no access to data from the field
- Estimations based on open source material, e.g.:



Vattelfall ("Technische Anschlussbedingungen – Fahrkurve H")

Stress profile for heat meters?

- Mean outdoor temperatures comparison (source: www.klimatabelle.de) :

Month	Germany Frankfurt(Main)		Sweden Lulea	
	Outside temperature / °C	Inlet temperature / °C	Outside temperature / °C	Inlet temperature / °C
January	-2	108	-15	130
February	-1	107	-15	130
March	2	102	-10	123
April	6	95	-3	110
May	9	88	2	101
June	13	83	9	80
July	15	79	11	85
August	14	80	10	87
September	11	86	4	98
October	7	93	0	105
November	3	99	-6	116
December	0	105	-12	126

Stress profile for heat meters?

Temperature / °C	Germany Frankfurt(Main)	Sweden Lulea	China Harbin
130	0 %	33 %	42 %
120	0 %	17 %	0 %
110	33 %	17 %	17 %
100	25 %	8 %	8 %
90	33 %	25 %	8 %
80	8 %	0 %	25 %
70	0%	0 %	0 %

- There is no general stress profile
- Topic for standardisation: Definition of a standard profile

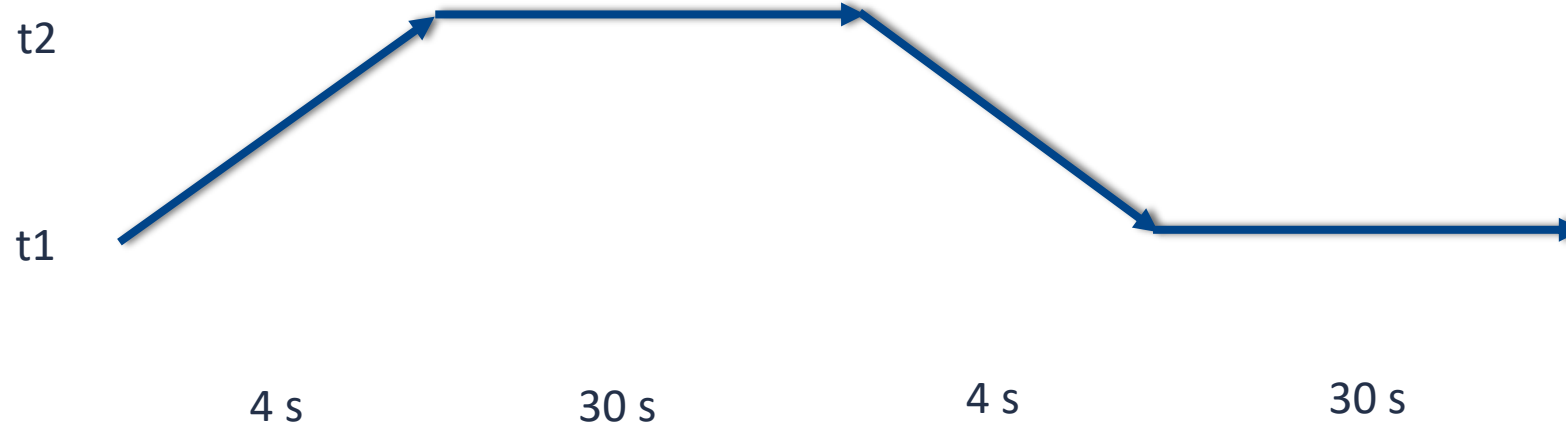
What we tested



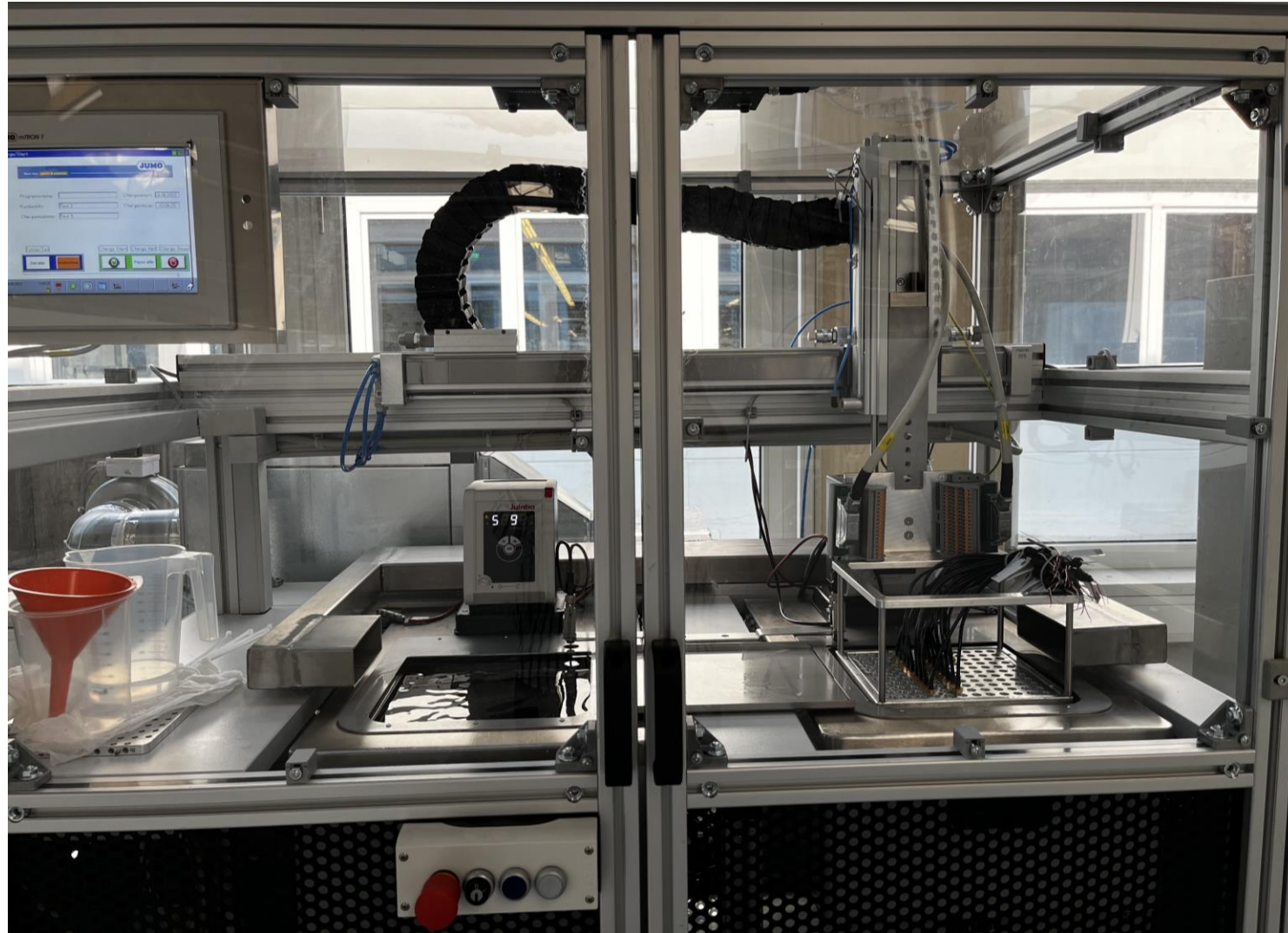
- JUMO temperature probes (902428/50)
- SMD Pt500



- Test procedure similar to EN 1434-4:2023 (7.8.3)
 - Cyclic temperature stress (*low temperature (LT)*)
 - Cyclic temperature stress (Max. temperature)



How we tested: Equipment



How we tested: Equipment

- Weiss Type vötschoven Lab 60 premium
- Temperature range RT+10 °C to 300 °C
- Temperature homogeneity $\pm 1 \%$
- Temperature stability $\pm 0.1 \text{ K}$



What we expected:

- Typical behaviour of temperature sensors (bare SMD chip): Exponential
- Typical behaviour for ageing in other fields is most likely either exponential (Arrhenius behaviour) or Weibull

$$\pi_T = \exp \left[\frac{E_{a1}}{k_0} \left(\frac{1}{T_{\text{ref}}} - \frac{1}{T_{\text{op}}} \right) \right]$$

$$f(x; \lambda, \beta) = \begin{cases} \frac{\beta}{\lambda} \left(\frac{x}{\lambda} \right)^{\beta-1} e^{-\left(\frac{x}{\lambda} \right)^\beta}, & x \geq 0 \\ 0, & x < 0 \end{cases}$$

- Test for T_{\max} and ΔT

No.	$T_{\min} / ^\circ\text{C}$	$T_{\max} / ^\circ\text{C}$
1	10	85
2	10	105
3	10	140
4	30	105

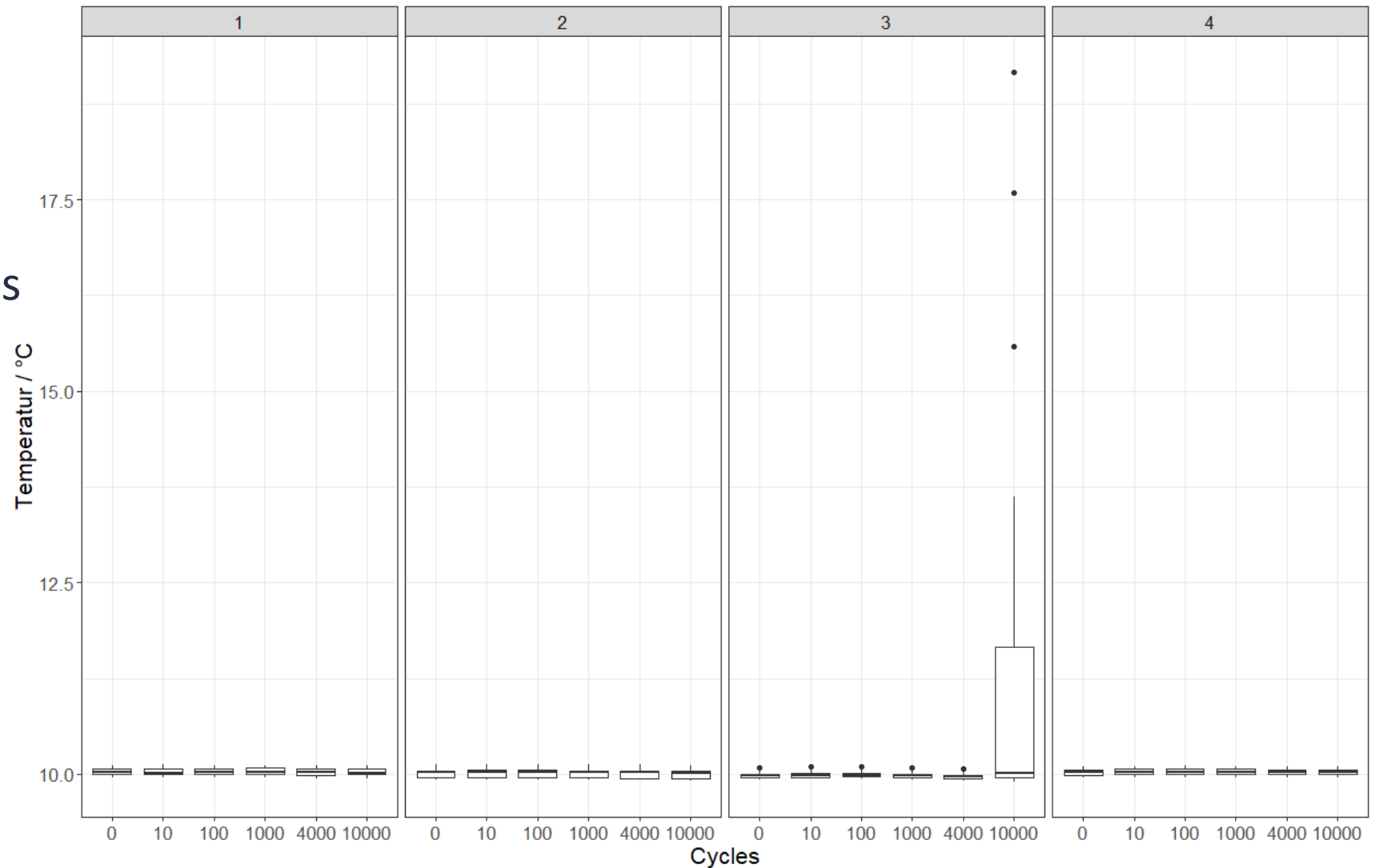
- Exponential behaviour expected. Measurements after 10, 100 , 1000 , 4000 and 10000 cycles
- After that a test with high temperature (150 °C): 22h T_{\max} , 2h RT

Results: Temperature measurement at 10 °C



Group 3 has significant failures

Soldering (cable to PCB) most likely cause for failure



Results: Resistance at 0 °C

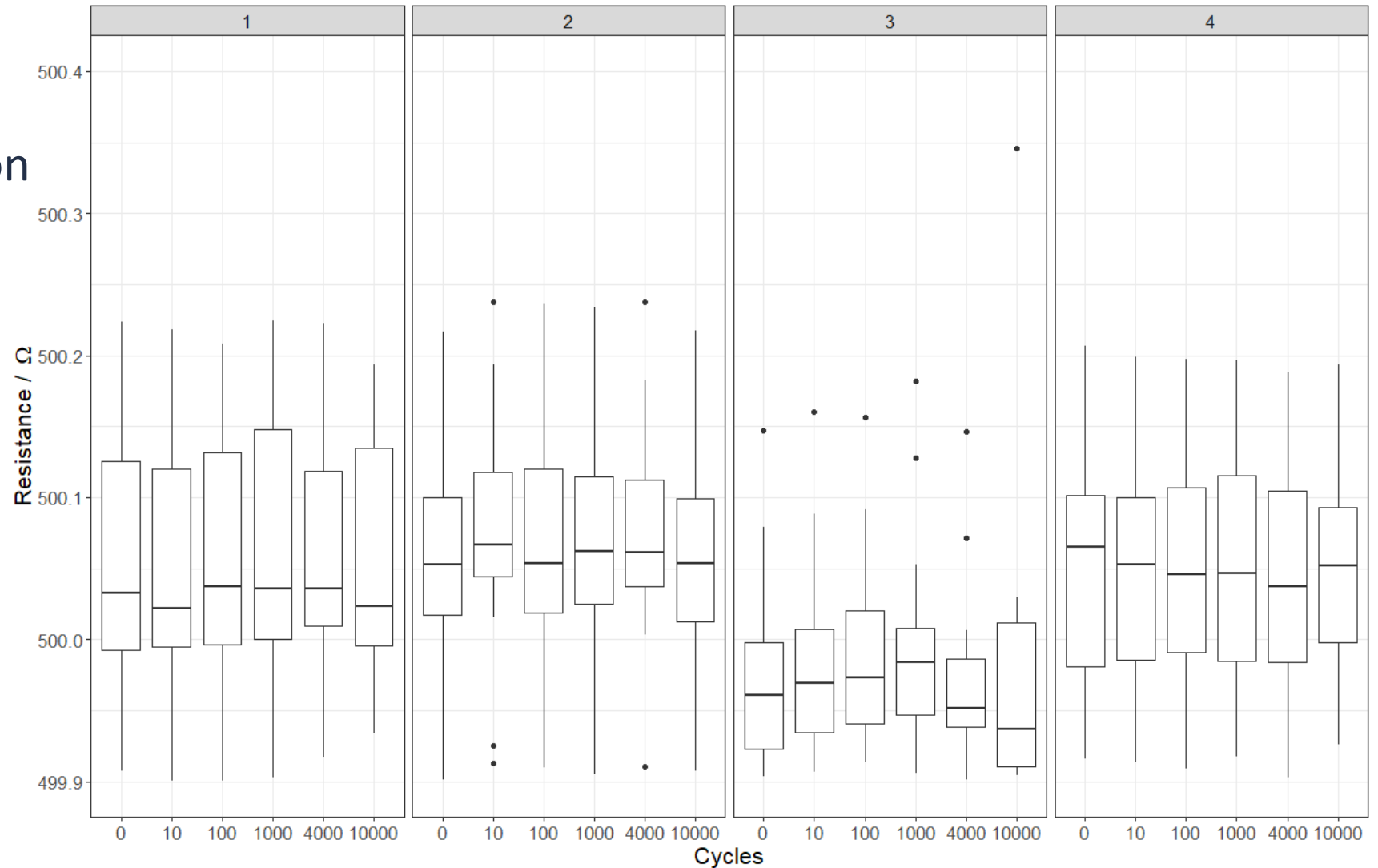


Group 3 has clearest indication for double exponential behaviour

Effect size small

Model with *one* exponential curve is not valid

Fit for double exponential model doesn't converge



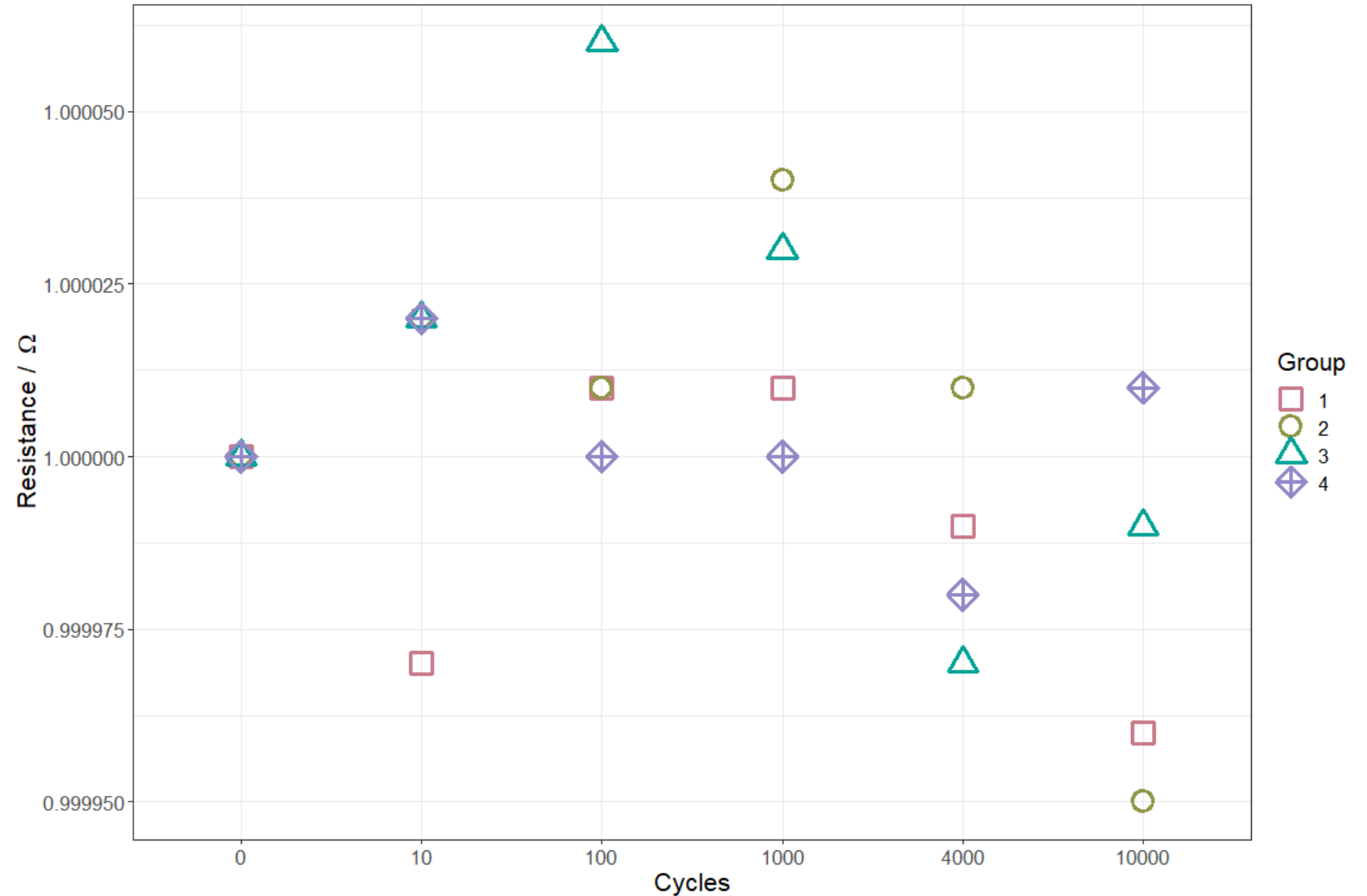
Results: Normalisation



Median values taken

Normalised to 0 cycles

There is a general trend observable

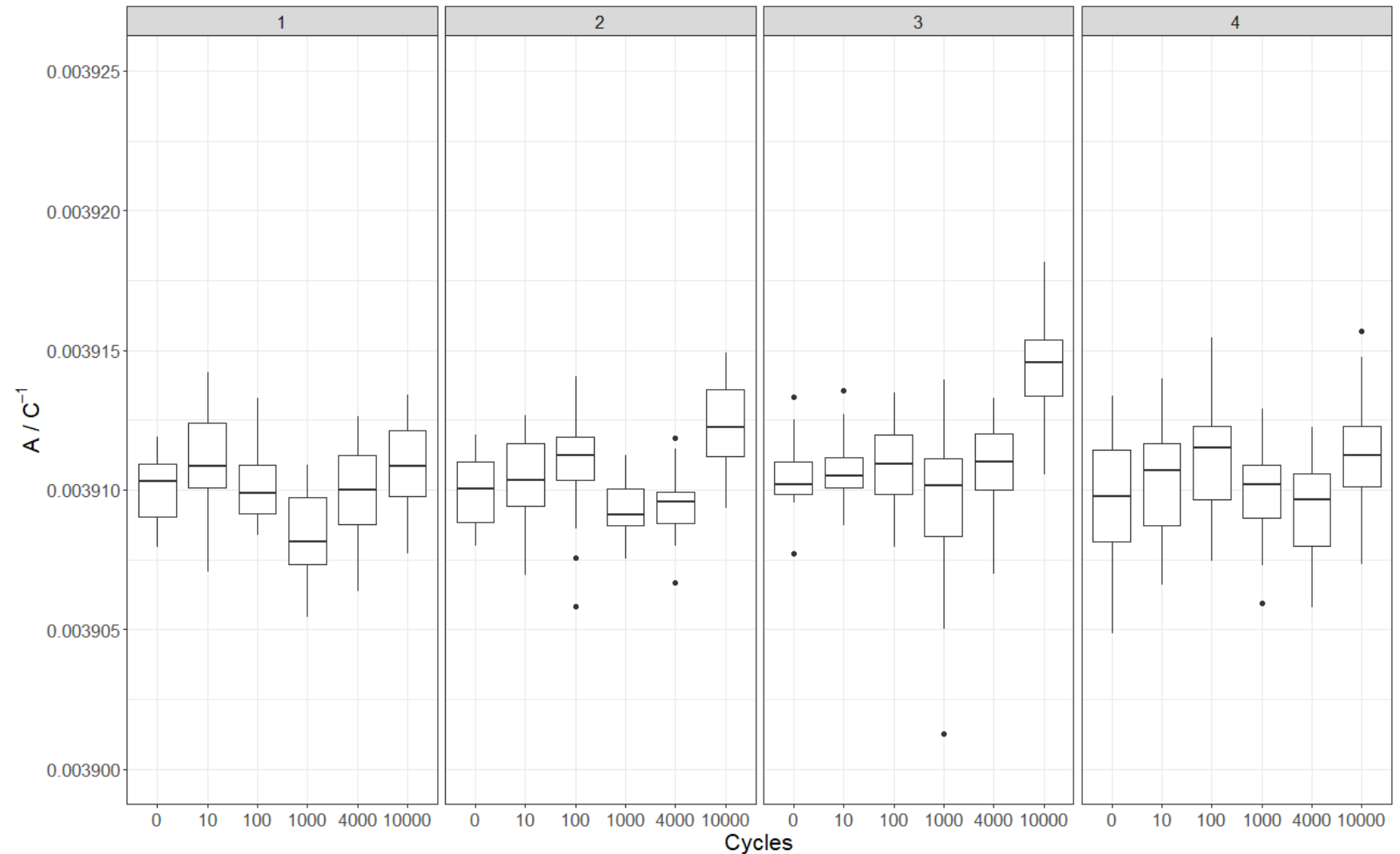


Results: A value

- $R(T) = R_0 \cdot (1 + AT + BT^2)$

Multiple ageing effects can be observed

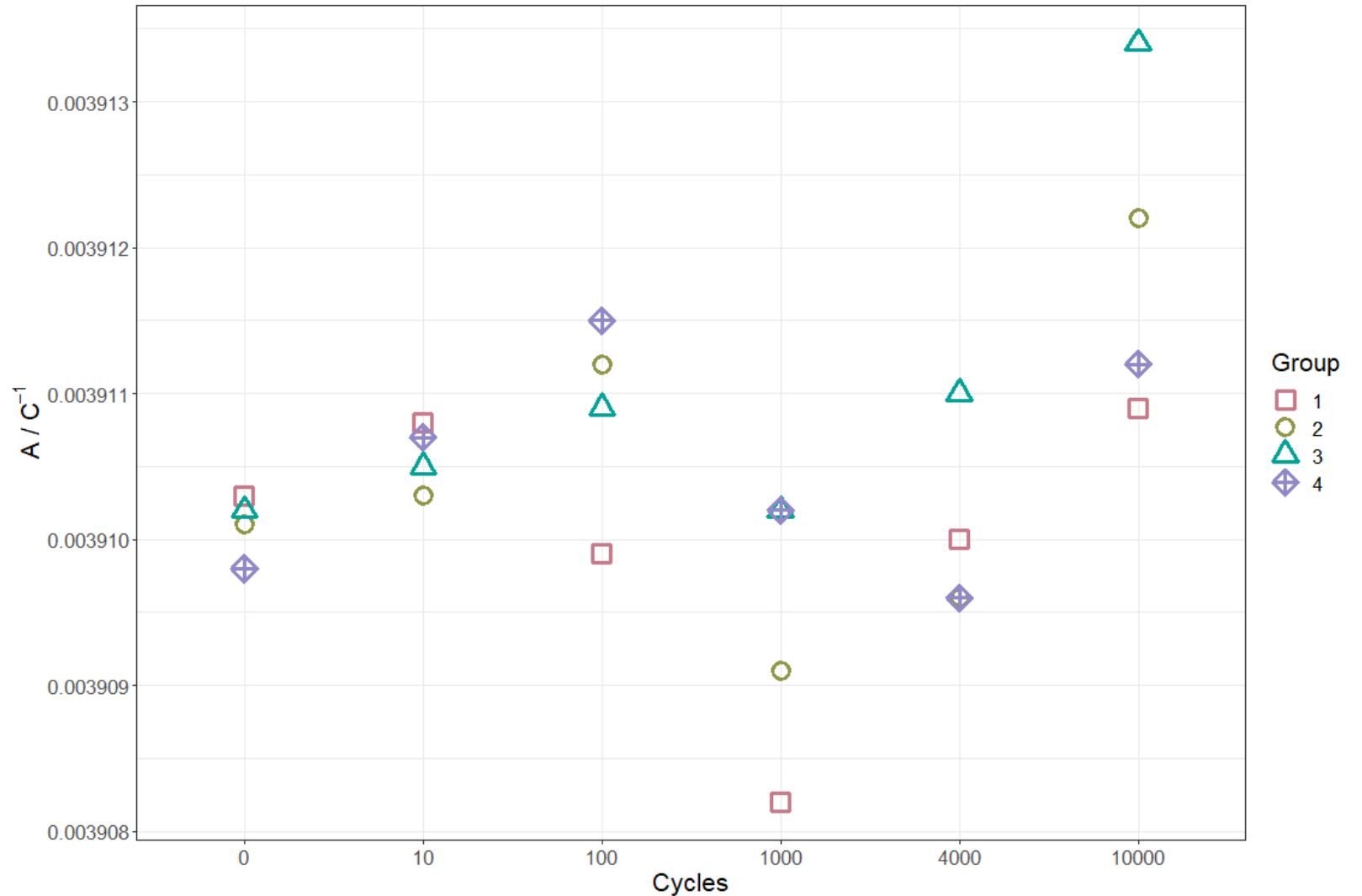
Pre-stages for failure at 10k cycles for high temperature stress can be observed



Results: Comparison of A values

Short term ageing can be distinguished from long term

Comparison of 0 cycles and 4k cycles measurement doesn't reveal ageing



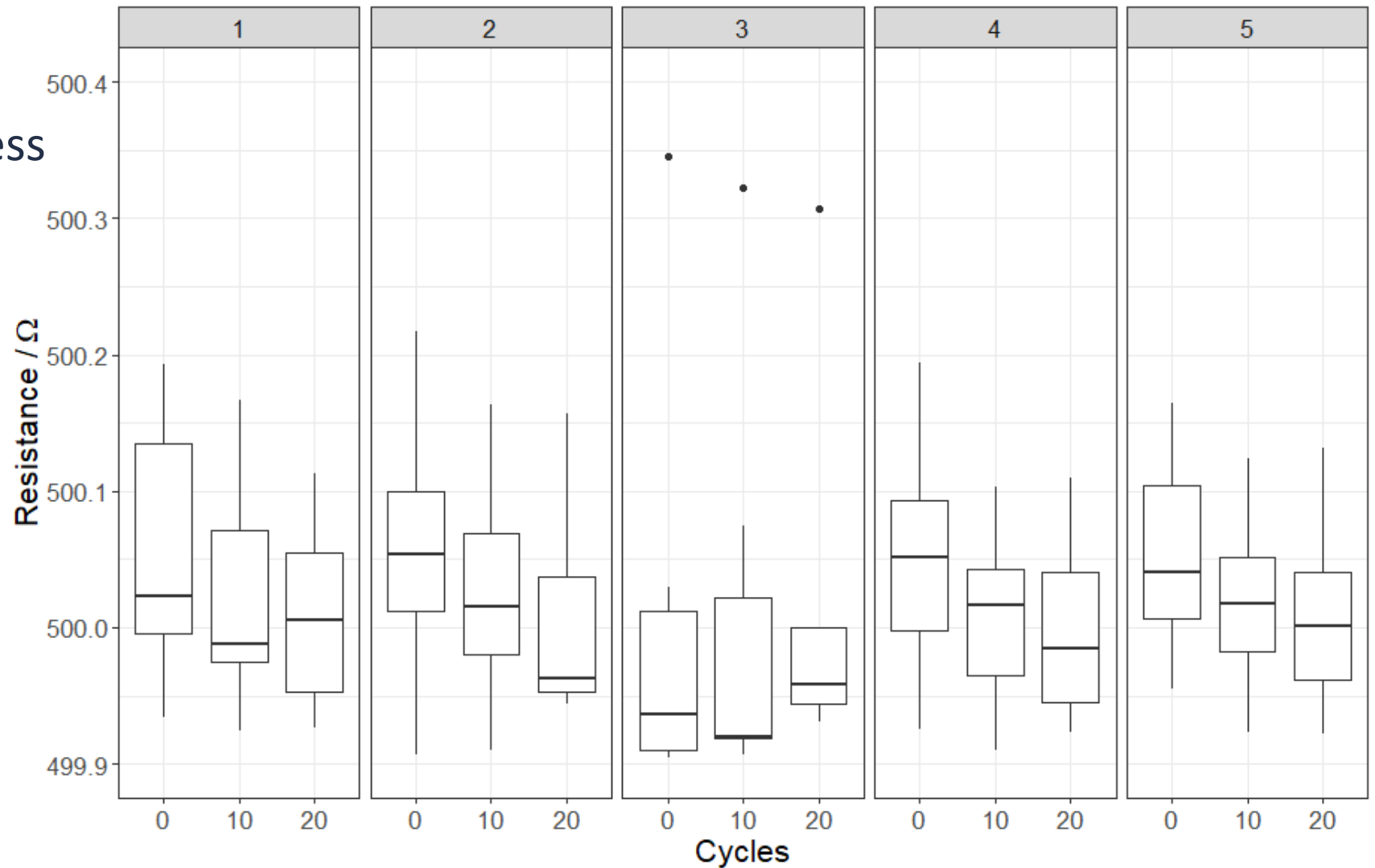
Results: High temperature stress

Group 5 has no LT cycle stress

0 cycles for group 1-4 is the last measurement for LT cycles

Group 3 has signs of catastrophic failure

Other groups age

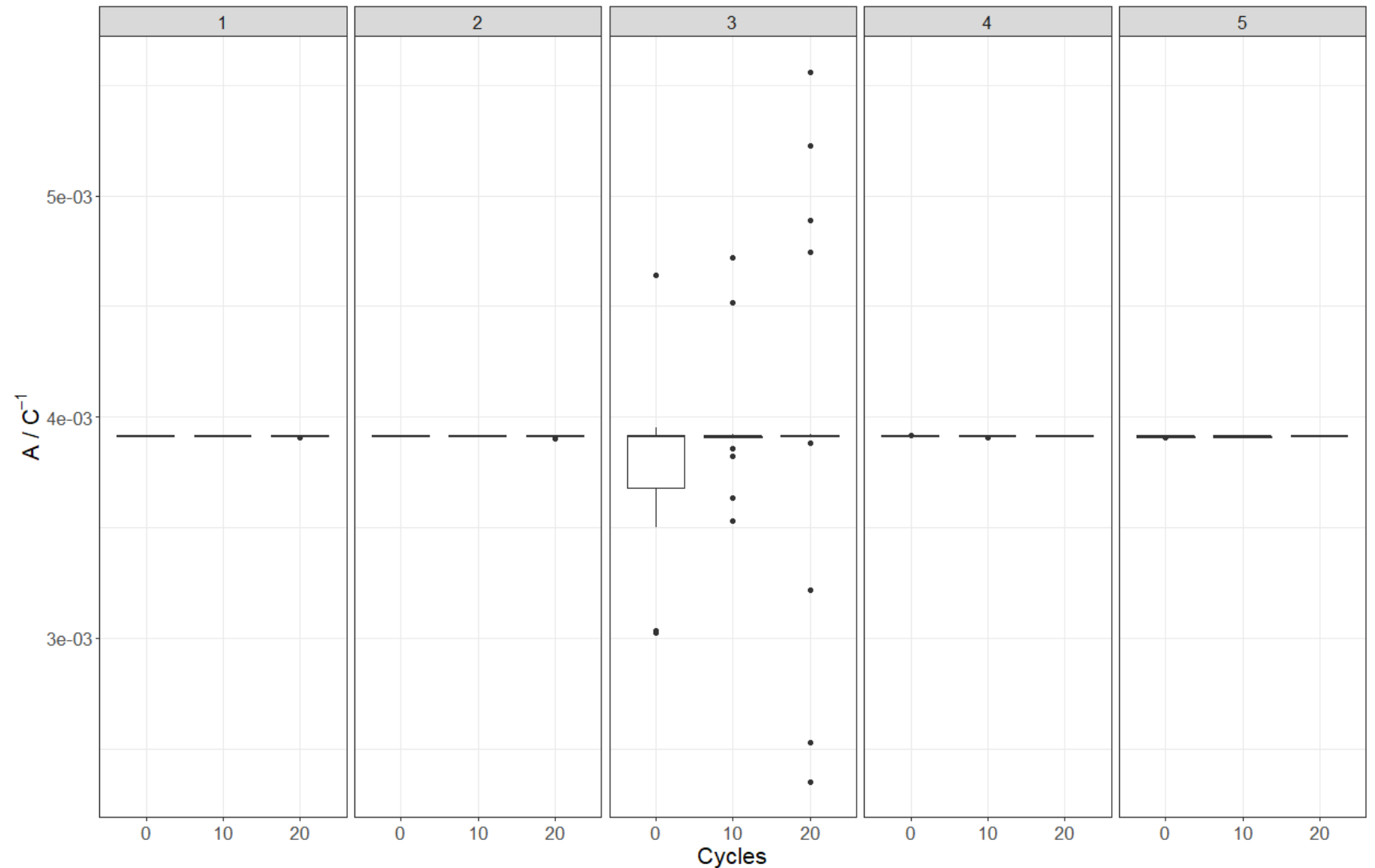


Results: High temperature stress

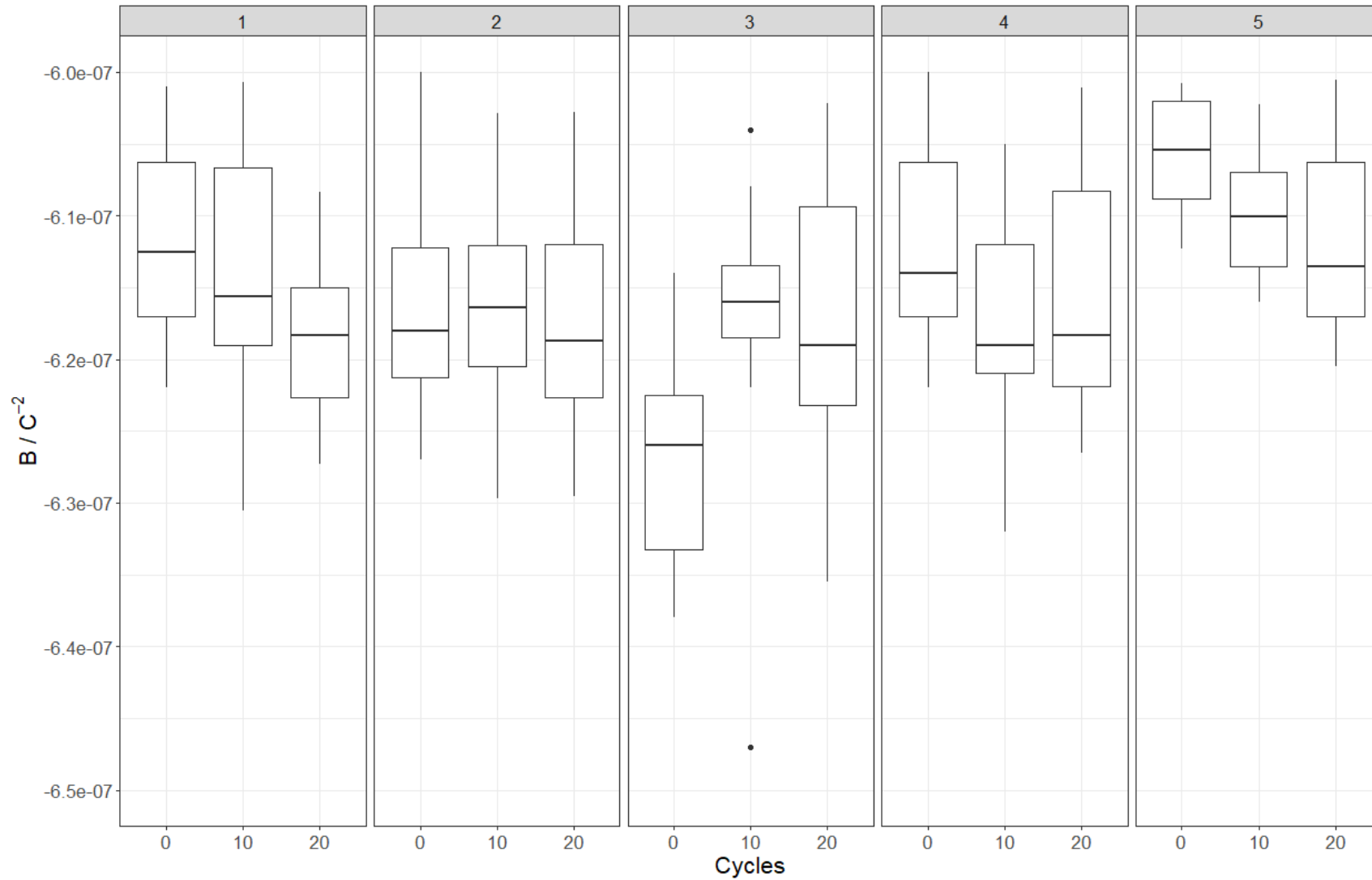


Group 3 has signs of catastrophic failure and it is getting worse

Other groups remain ok

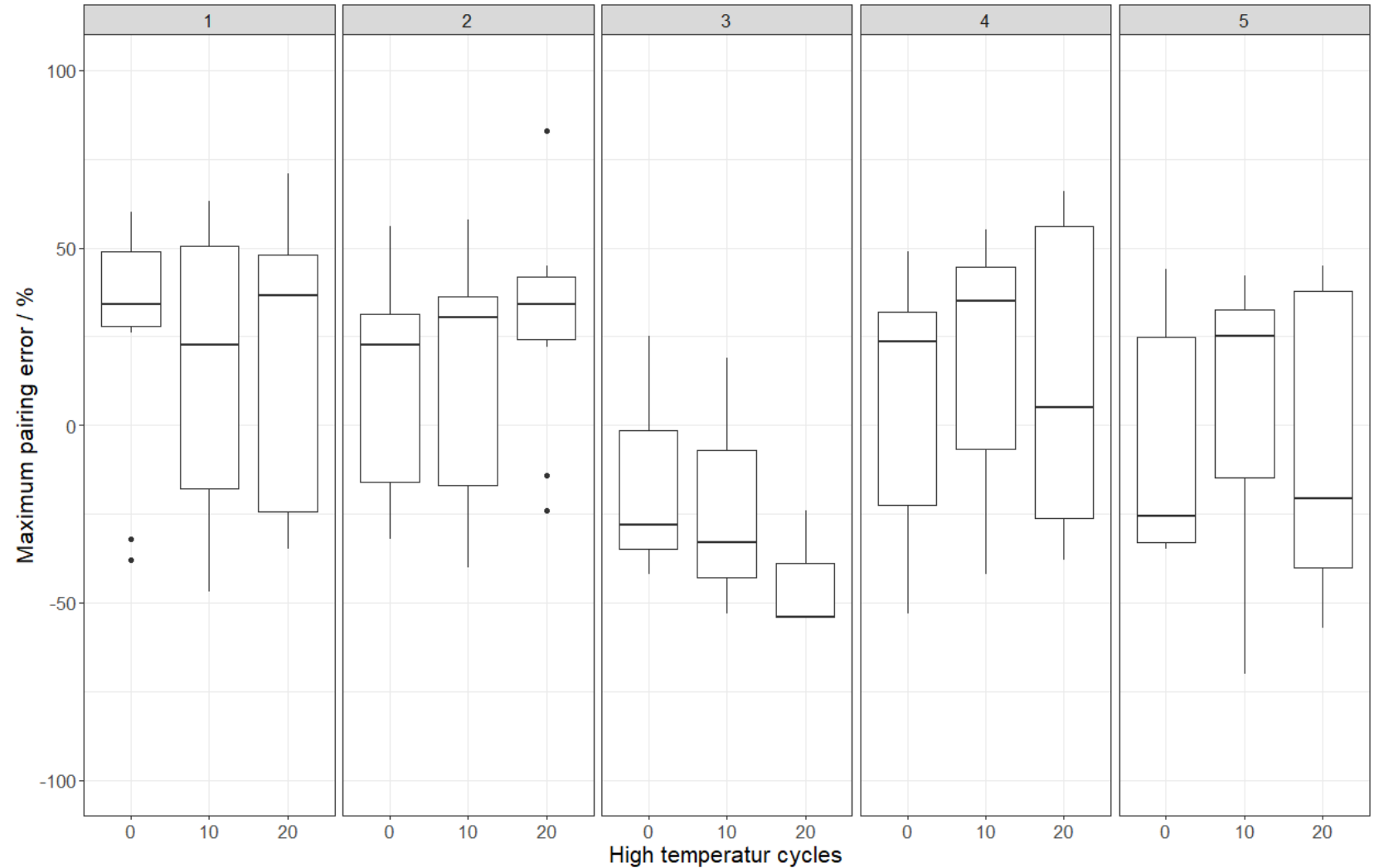


Results: High temperature stress



Results: High temperature stress

Pairs with ok sensor remain within 1 MPE ($\Delta\theta_{min} = 3K$)



- The expected exponential behaviour was not verified
- Double exponential behaviour is more difficult to model
- **A** value is an indicator for stress (ageing of individual components)
- Good thermometers remain pairs within 1 MPE

- Reproducibility needs to be checked
- This was one type of thermometer → Other types will be tested
- Work on a model with competing exponential behaviour

I look forward to your feedback!

Dr. Ivan Jursic

**Global Development - Research & Test
Measures and Measuring Methods**

JUMO GmbH & Co. KG
Moritz-Juchheim Straße 1
36039 Fulda
<https://www.jumo.de>

Contact us



Simon Munker

Technical Product Manager

☎ +49 661 6003 3654

✉ Simon.Muenker@jumo.net



Daniel Bott

Market Segment Manager

☎ +49 661 6003 9303

✉ Daniel.Bott@jumo.net



Tobias Firle

Techn. & Strat. Product Manager

☎ +49 661 6003 9396

✉ Tobias.Firle@jumo.net

THANK YOU